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Kind regards,

Team Nexperia

# 74LVC16245A; 74LVCH16245A

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

Rev. 12 — 13 February 2012

Product data sheet

## 1. General description

The 74LVC16245A; 74LVCH16245A are 16-bit transceivers featuring non-inverting 3-state bus compatible outputs in both send and receive directions. The device features two output enable ( $\overline{\text{nOE}}$ ) inputs for easy cascading and two send/receive ( $\overline{\text{nDIR}}$ ) inputs for direction control.  $\overline{\text{nOE}}$  controls the outputs so that the buses are effectively isolated. This device can be used as two 8-bit transceivers or one 16-bit transceiver.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

The 74LVCH16245A bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

## 2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- High-impedance when  $V_{CC} = 0$  V
- All data inputs have bus hold (74LVCH16245A only)
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-B exceeds 200 V
  - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from  $-40$  °C to  $+85$  °C and  $-40$  °C to  $+125$  °C



### 3. Ordering information

Table 1. Ordering information

| Type number                       | Temperature range | Package |                                                                                                                         |           |
|-----------------------------------|-------------------|---------|-------------------------------------------------------------------------------------------------------------------------|-----------|
|                                   |                   | Name    | Description                                                                                                             | Version   |
| 74LVC16245ADL<br>74LVCH16245ADL   | –40 °C to +125 °C | SSOP48  | plastic shrink small outline package; 48 leads;<br>body width 7.5 mm                                                    | SOT370-1  |
| 74LVC16245ADGG<br>74LVCH16245ADGG | –40 °C to +125 °C | TSSOP48 | plastic thin shrink small outline package;<br>48 leads; body width 6.1 mm                                               | SOT362-1  |
| 74LVC16245AEV<br>74LVCH16245AEV   | –40 °C to +125 °C | VFBGA56 | plastic very thin fine-pitch ball grid array package;<br>56 balls; body 4.5 × 7 × 0.65 mm                               | SOT702-1  |
| 74LVC16245ABX<br>74LVCH16245ABX   | –40 °C to +125 °C | HXQFN60 | plastic compatible thermal enhanced extremely<br>thin quad flat package; no leads; 60 terminals;<br>body 4 × 6 × 0.5 mm | SOT1134-2 |

### 4. Functional diagram

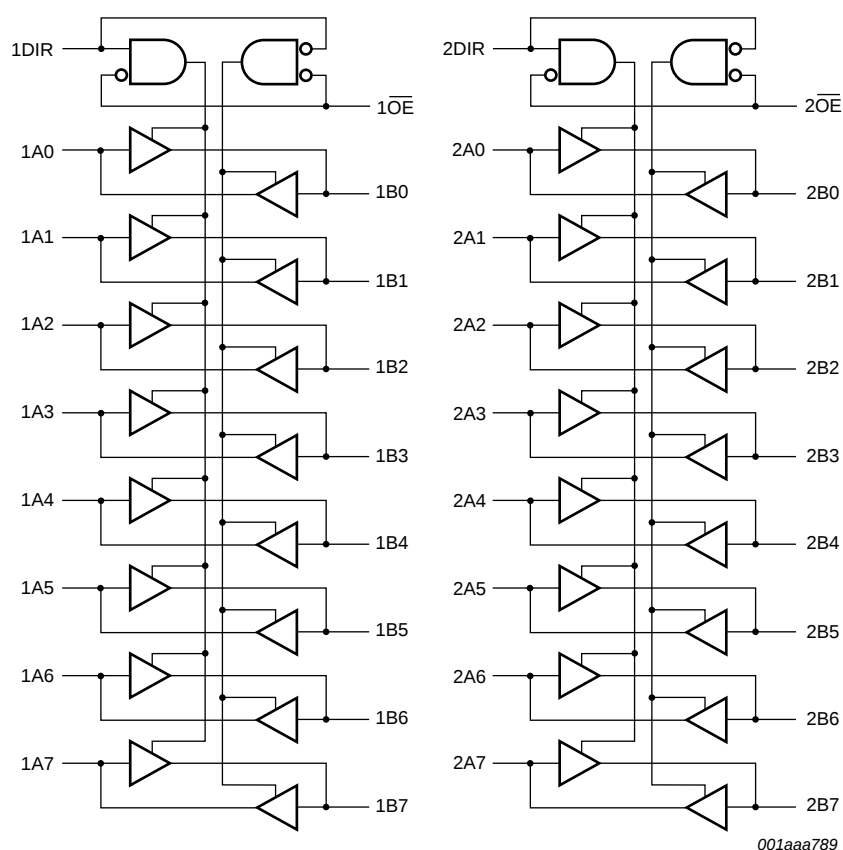


Fig 1. Logic symbol

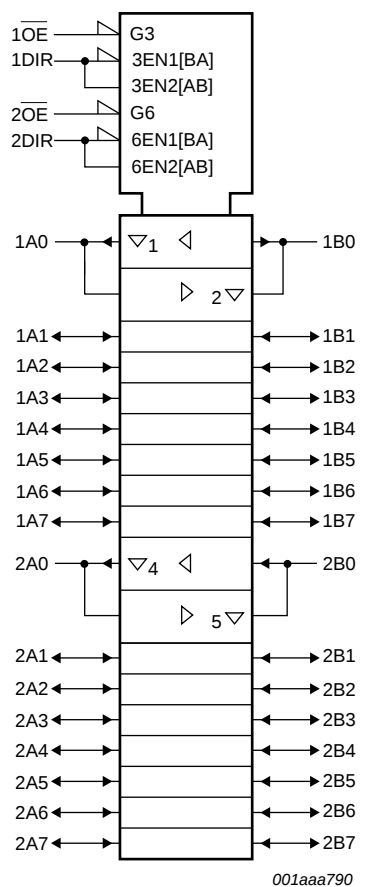


Fig 2. IEC logic symbol

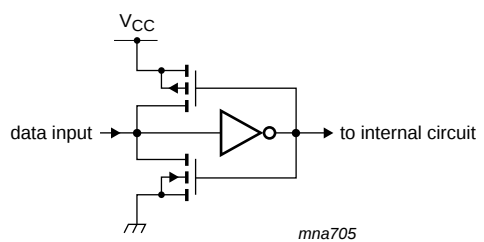
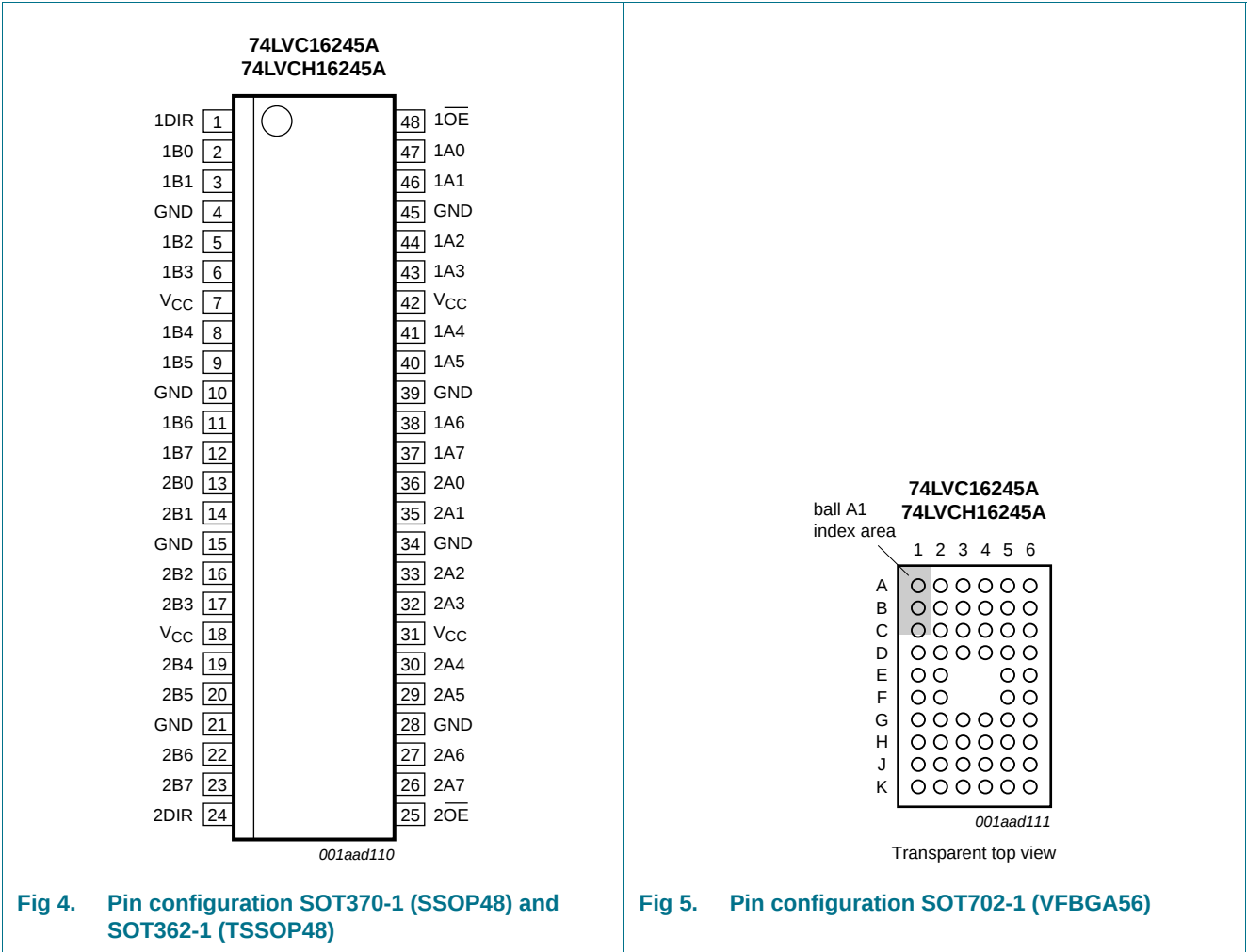
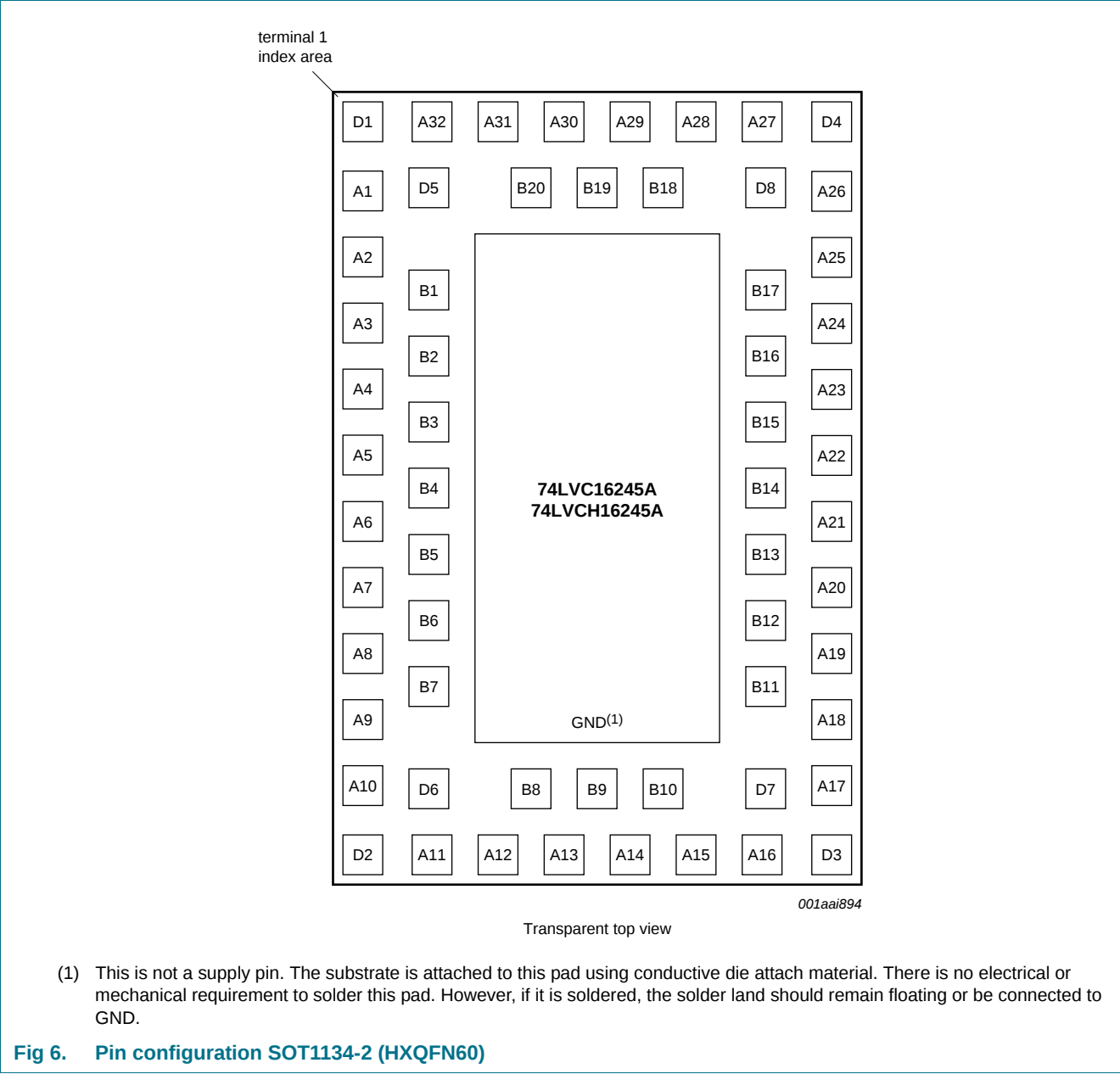


Fig 3. Bus hold circuit

5. Pinning information

5.1 Pinning





## 5.2 Pin description

Table 2. Pin description

| Symbol                              | Pin                            |                                |                                                      | Description                      |
|-------------------------------------|--------------------------------|--------------------------------|------------------------------------------------------|----------------------------------|
|                                     | SOT370-1 and SOT362-1          | SOT702-1                       | SOT1134-2                                            |                                  |
| 1DIR, 2DIR                          | 1, 24                          | A1, K1                         | A30, A13                                             | direction control input          |
| 1B0 to 1B7                          | 2, 3, 5, 6, 8, 9, 11, 12       | B2, B1, C2, C1, D2, D1, E2, E1 | B20, A31, D5, D1, A2, B2, B3, A5                     | data input/output                |
| 2B0 to 2B7                          | 13, 14, 16, 17, 19, 20, 22, 23 | F1, F2, G1, G2, H1, H2, J1, J2 | A6, B5, B6, A9, D2, D6, A12, B8                      | data input/output                |
| GND                                 | 4, 10, 15, 21, 28, 34, 39, 45  | B3, B4, D3, D4, G3, G4, J3, J4 | A32, A3, A8, A11, A16, A19, A24, A27                 | ground (0 V)                     |
| V <sub>CC</sub>                     | 7, 18, 31, 42                  | C3, C4, H3, H4                 | A1, A10, A17, A26                                    | supply voltage                   |
| $\overline{1OE}$ , $\overline{2OE}$ | 48, 25                         | A6, K6                         | A29, A14                                             | output enable input (active LOW) |
| 1A0 to 1A7                          | 47, 46, 44, 43, 41, 40, 38, 37 | B5, B6, C5, C6, D5, D6, E5, E6 | B18, A28, D8, D4, A25, B16, B15, A22                 | data input/output                |
| 2A0 to 2A7                          | 36, 35, 33, 32, 30, 29, 27, 26 | F6, F5, G6, G5, H6, H5, J6, J5 | A21, B13, B12, A18, D3, D7, A15, B10                 | data input/output                |
| n.c.                                | -                              | A2, A3, A4, A5, K2, K3, K4, K5 | A4, A7, A20, A23, B1, B4, B7, B9, B11, B14, B17, B19 | not connected                    |

## 6. Functional description

Table 3. Function table<sup>[1]</sup>

| Inputs           |      | Outputs   |           |
|------------------|------|-----------|-----------|
| $\overline{nOE}$ | nDIR | nAn       | nBn       |
| L                | L    | nAn = nBn | inputs    |
| L                | H    | inputs    | nBn = nAn |
| H                | X    | Z         | Z         |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions                     | Min      | Max            | Unit |
|-----------|-------------------------|--------------------------------|----------|----------------|------|
| $V_{CC}$  | supply voltage          |                                | -0.5     | +6.5           | V    |
| $I_{IK}$  | input clamping current  | $V_I < 0$ V                    | -50      | -              | mA   |
| $V_I$     | input voltage           |                                | [1] -0.5 | +6.5           | V    |
| $I_{OK}$  | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ V  | -        | $\pm 50$       | mA   |
| $V_O$     | output voltage          | output HIGH or LOW             | [2] -0.5 | $V_{CC} + 0.5$ | V    |
|           |                         | output 3-state                 | [2] -0.5 | +6.5           | V    |
| $I_O$     | output current          | $V_O = 0$ V to $V_{CC}$        | -        | $\pm 50$       | mA   |
| $I_{CC}$  | supply current          |                                | -        | 100            | mA   |
| $I_{GND}$ | ground current          |                                | -100     | -              | mA   |
| $T_{stg}$ | storage temperature     |                                | -65      | +150           | °C   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40$ °C to +125 °C; |          |                |      |
|           |                         | (T)SSOP48 package              | [3] -    | 500            | mW   |
|           |                         | VFBGA56 package                | [4] -    | 1000           | mW   |
|           |                         | HXQFN60 package                | [4] -    | 1000           | mW   |

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] Above 60 °C the value of  $P_{tot}$  derates linearly with 5.5 mW/K.

[4] Above 70 °C the value of  $P_{tot}$  derates linearly with 1.8 mW/K.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

| Symbol              | Parameter                           | Conditions                | Min  | Typ | Max      | Unit |
|---------------------|-------------------------------------|---------------------------|------|-----|----------|------|
| $V_{CC}$            | supply voltage                      |                           | 1.65 | -   | 3.6      | V    |
|                     |                                     | functional                | 1.2  | -   | 3.6      | V    |
| $V_I$               | input voltage                       |                           | 0    | -   | 5.5      | V    |
| $V_O$               | output voltage                      | output HIGH or LOW        | 0    | -   | $V_{CC}$ | V    |
|                     |                                     | output 3-state            | 0    | -   | 5.5      | V    |
| $T_{amb}$           | ambient temperature                 | in free air               | -40  | -   | +125     | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 1.2$ V to 2.7 V | 0    | -   | 20       | ns/V |
|                     |                                     | $V_{CC} = 2.7$ V to 3.6 V | 0    | -   | 10       | ns/V |

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                                  | Conditions                                                                                                      | –40 °C to +85 °C       |                    |                        | –40 °C to +125 °C      |                        | Unit |
|------------------|--------------------------------------------|-----------------------------------------------------------------------------------------------------------------|------------------------|--------------------|------------------------|------------------------|------------------------|------|
|                  |                                            |                                                                                                                 | Min                    | Typ <sup>[1]</sup> | Max                    | Min                    | Max                    |      |
| V <sub>IH</sub>  | HIGH-level input voltage                   | V <sub>CC</sub> = 1.2 V                                                                                         | 1.08                   | -                  | -                      | 1.08                   | -                      | V    |
|                  |                                            | V <sub>CC</sub> = 1.65 V to 1.95 V                                                                              | 0.65 × V <sub>CC</sub> | -                  | -                      | 0.65 × V <sub>CC</sub> | -                      | V    |
|                  |                                            | V <sub>CC</sub> = 2.3 V to 2.7 V                                                                                | 1.7                    | -                  | -                      | 1.7                    | -                      | V    |
|                  |                                            | V <sub>CC</sub> = 2.7 V to 3.6 V                                                                                | 2.0                    | -                  | -                      | 2.0                    | -                      | V    |
| V <sub>IL</sub>  | LOW-level input voltage                    | V <sub>CC</sub> = 1.2 V                                                                                         | -                      | -                  | 0.12                   | -                      | 0.12                   | V    |
|                  |                                            | V <sub>CC</sub> = 1.65 V to 1.95 V                                                                              | -                      | -                  | 0.35 × V <sub>CC</sub> | -                      | 0.35 × V <sub>CC</sub> | V    |
|                  |                                            | V <sub>CC</sub> = 2.3 V to 2.7 V                                                                                | -                      | -                  | 0.7                    | -                      | 0.7                    | V    |
|                  |                                            | V <sub>CC</sub> = 2.7 V to 3.6 V                                                                                | -                      | -                  | 0.8                    | -                      | 0.8                    | V    |
| V <sub>OH</sub>  | HIGH-level output voltage                  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                                             |                        |                    |                        |                        |                        |      |
|                  |                                            | I <sub>O</sub> = –100 µA; V <sub>CC</sub> = 1.65 V to 3.6 V                                                     | V <sub>CC</sub> – 0.2  | -                  | -                      | V <sub>CC</sub> – 0.3  | -                      | V    |
|                  |                                            | I <sub>O</sub> = –4 mA; V <sub>CC</sub> = 1.65 V                                                                | 1.2                    | -                  | -                      | 1.05                   | -                      | V    |
|                  |                                            | I <sub>O</sub> = –8 mA; V <sub>CC</sub> = 2.3 V                                                                 | 1.8                    | -                  | -                      | 1.65                   | -                      | V    |
|                  |                                            | I <sub>O</sub> = –12 mA; V <sub>CC</sub> = 2.7 V                                                                | 2.2                    | -                  | -                      | 2.05                   | -                      | V    |
|                  |                                            | I <sub>O</sub> = –18 mA; V <sub>CC</sub> = 3.0 V                                                                | 2.4                    | -                  | -                      | 2.25                   | -                      | V    |
|                  |                                            | I <sub>O</sub> = –24 mA; V <sub>CC</sub> = 3.0 V                                                                | 2.2                    | -                  | -                      | 2.0                    | -                      | V    |
| V <sub>OL</sub>  | LOW-level output voltage                   | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                                             |                        |                    |                        |                        |                        |      |
|                  |                                            | I <sub>O</sub> = 100 µA; V <sub>CC</sub> = 1.65 V to 3.6 V                                                      | -                      | -                  | 0.2                    | -                      | 0.3                    | V    |
|                  |                                            | I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V                                                                 | -                      | -                  | 0.45                   | -                      | 0.65                   | V    |
|                  |                                            | I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V                                                                  | -                      | -                  | 0.6                    | -                      | 0.8                    | V    |
|                  |                                            | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V                                                                 | -                      | -                  | 0.4                    | -                      | 0.6                    | V    |
|                  |                                            | I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V                                                                 | -                      | -                  | 0.55                   | -                      | 0.8                    | V    |
| I <sub>I</sub>   | input leakage current <sup>[2]</sup>       | V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 3.6 V                                                          | -                      | ±0.1               | ±5                     | -                      | ±20                    | µA   |
| I <sub>OZ</sub>  | OFF-state output current <sup>[2][3]</sup> | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = 5.5 V or GND; V <sub>CC</sub> = 3.6 V    | -                      | ±0.1               | ±5                     | -                      | ±20                    | µA   |
| I <sub>OFF</sub> | power-off leakage current                  | V <sub>I</sub> or V <sub>O</sub> = 5.5 V; V <sub>CC</sub> = 0.0 V                                               | -                      | ±0.1               | ±10                    | -                      | ±20                    | µA   |
| I <sub>CC</sub>  | supply current                             | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 3.6 V                          | -                      | 0.1                | 20                     | -                      | 80                     | µA   |
| ΔI <sub>CC</sub> | additional supply current                  | per input pin; V <sub>I</sub> = V <sub>CC</sub> – 0.6 V; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 2.7 V to 3.6 V | -                      | 5                  | 500                    | -                      | 5000                   | µA   |
| C <sub>I</sub>   | input capacitance                          | V <sub>CC</sub> = 0 V to 3.6 V; V <sub>I</sub> = GND to V <sub>CC</sub>                                         | -                      | 5.0                | -                      | -                      | -                      | pF   |
| C <sub>I/O</sub> | input/output capacitance                   | V <sub>CC</sub> = 0 V to 3.6 V; V <sub>I</sub> = GND to V <sub>CC</sub>                                         | -                      | 10                 | -                      | -                      | -                      | pF   |

**Table 6.** Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol            | Parameter                                         | Conditions                                      | –40 °C to +85 °C |                    |     | –40 °C to +125 °C |     | Unit |
|-------------------|---------------------------------------------------|-------------------------------------------------|------------------|--------------------|-----|-------------------|-----|------|
|                   |                                                   |                                                 | Min              | Typ <sup>[1]</sup> | Max | Min               | Max |      |
| I <sub>BHL</sub>  | bus hold LOW current <sup>[4][5]</sup>            | V <sub>CC</sub> = 1.65; V <sub>I</sub> = 0.58 V | 10               | -                  | -   | 10                | -   | μA   |
|                   |                                                   | V <sub>CC</sub> = 2.3; V <sub>I</sub> = 0.7 V   | 30               | -                  | -   | 25                | -   | μA   |
|                   |                                                   | V <sub>CC</sub> = 3.0; V <sub>I</sub> = 0.8 V   | 75               | -                  | -   | 60                | -   | μA   |
| I <sub>BHH</sub>  | bus hold HIGH current <sup>[4][5]</sup>           | V <sub>CC</sub> = 1.65; V <sub>I</sub> = 1.07 V | –10              | -                  | -   | –10               | -   | μA   |
|                   |                                                   | V <sub>CC</sub> = 2.3; V <sub>I</sub> = 1.7 V   | –30              | -                  | -   | –25               | -   | μA   |
|                   |                                                   | V <sub>CC</sub> = 3.0; V <sub>I</sub> = 2.0 V   | –75              | -                  | -   | –60               | -   | μA   |
| I <sub>BHLO</sub> | bus hold LOW overdrive current <sup>[4][6]</sup>  | V <sub>CC</sub> = 1.95 V                        | 200              | -                  | -   | 200               | -   | μA   |
|                   |                                                   | V <sub>CC</sub> = 2.7 V                         | 300              | -                  | -   | 300               | -   | μA   |
|                   |                                                   | V <sub>CC</sub> = 3.6 V                         | 500              | -                  | -   | 500               | -   | μA   |
| I <sub>BHHO</sub> | bus hold HIGH overdrive current <sup>[4][6]</sup> | V <sub>CC</sub> = 1.95 V                        | –200             | -                  | -   | –200              | -   | μA   |
|                   |                                                   | V <sub>CC</sub> = 2.7 V                         | –300             | -                  | -   | –300              | -   | μA   |
|                   |                                                   | V <sub>CC</sub> = 3.6 V                         | –500             | -                  | -   | –500              | -   | μA   |

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.[2] The bus hold circuit is switched off when V<sub>I</sub> > V<sub>CC</sub> allowing 5.5 V on the input terminal.[3] For I/O ports the parameter I<sub>OZ</sub> includes the input leakage current.

[4] Valid for data inputs of bus hold parts only (74LVCH16245A). Note that control inputs do not have a bus hold circuit.

[5] The specified sustaining current at the data input holds the input below the specified V<sub>I</sub> level.

[6] The specified overdrive current at the data input forces the data input to the opposite input state.

## 10. Dynamic characteristics

**Table 7.** Dynamic characteristicsVoltages are referenced to GND (ground = 0 V). For test circuit see [Figure 9](#).

| Symbol          | Parameter         | Conditions                                                          | –40 °C to +85 °C |                    |      | –40 °C to +125 °C |      | Unit |
|-----------------|-------------------|---------------------------------------------------------------------|------------------|--------------------|------|-------------------|------|------|
|                 |                   |                                                                     | Min              | Typ <sup>[2]</sup> | Max  | Min               | Max  |      |
| t <sub>pd</sub> | propagation delay | nAn to nBn; nBn to nAn; see <a href="#">Figure 7</a> <sup>[1]</sup> |                  |                    |      |                   |      |      |
|                 |                   | V <sub>CC</sub> = 1.2 V                                             | -                | 13.0               | -    | -                 | -    | ns   |
|                 |                   | V <sub>CC</sub> = 1.65 V to 1.95 V                                  | 1.5              | 5.2                | 12.2 | 1.5               | 13.8 | ns   |
|                 |                   | V <sub>CC</sub> = 2.3 V to 2.7 V                                    | 1.0              | 2.8                | 6.0  | 1.0               | 6.7  | ns   |
|                 |                   | V <sub>CC</sub> = 2.7 V                                             | 1.0              | 2.7                | 4.7  | 1.0               | 6.0  | ns   |
|                 |                   | V <sub>CC</sub> = 3.0 V to 3.6 V                                    | 1.0              | 2.4                | 4.5  | 1.0               | 6.0  | ns   |
| t <sub>en</sub> | enable time       | nOE to nAn, nBn; see <a href="#">Figure 8</a> <sup>[1]</sup>        |                  |                    |      |                   |      |      |
|                 |                   | V <sub>CC</sub> = 1.2 V                                             | -                | 15.0               | -    | -                 | -    | ns   |
|                 |                   | V <sub>CC</sub> = 1.65 V to 1.95 V                                  | 1.5              | 5.9                | 15.0 | 1.5               | 16.9 | ns   |
|                 |                   | V <sub>CC</sub> = 2.3 V to 2.7 V                                    | 1.0              | 3.3                | 7.9  | 1.0               | 8.8  | ns   |
|                 |                   | V <sub>CC</sub> = 2.7 V                                             | 1.5              | 3.5                | 6.7  | 1.5               | 8.5  | ns   |
|                 |                   | V <sub>CC</sub> = 3.0 V to 3.6 V                                    | 1.0              | 2.7                | 5.5  | 1.0               | 7.0  | ns   |

**Table 7. Dynamic characteristics ...continued**

Voltages are referenced to GND (ground = 0 V). For test circuit see [Figure 9](#).

| Symbol    | Parameter                     | Conditions                                                   | -40 °C to +85 °C |                    |      | -40 °C to +125 °C |      | Unit |
|-----------|-------------------------------|--------------------------------------------------------------|------------------|--------------------|------|-------------------|------|------|
|           |                               |                                                              | Min              | Typ <sup>[2]</sup> | Max  | Min               | Max  |      |
| $t_{dis}$ | disable time                  | nOE to nAn, nBn; see <a href="#">Figure 8</a> <sup>[1]</sup> |                  |                    |      |                   |      |      |
|           |                               | $V_{CC} = 1.2 \text{ V}$                                     | -                | 11.0               | -    | -                 | -    | ns   |
|           |                               | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$                 | 1.0              | 4.9                | 13.1 | 1.0               | 14.7 | ns   |
|           |                               | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$                   | 0.5              | 2.7                | 7.1  | 0.5               | 7.9  | ns   |
|           |                               | $V_{CC} = 2.7 \text{ V}$                                     | 1.5              | 3.4                | 6.6  | 1.5               | 8.5  | ns   |
|           |                               | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$                   | 1.5              | 3.3                | 5.6  | 1.5               | 7.0  | ns   |
| $C_{PD}$  | power dissipation capacitance | per input; $V_I = \text{GND to } V_{CC}$ <sup>[3]</sup>      |                  |                    |      |                   |      |      |
|           |                               | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$                 | -                | 11.5               | -    | -                 | -    | pF   |
|           |                               | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$                   | -                | 15.2               | -    | -                 | -    | pF   |
|           |                               | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$                   | -                | 18.5               | -    | -                 | -    | pF   |

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

$t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

$t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .

[2] Typical values are measured at  $T_{amb} = 25 \text{ °C}$  and  $V_{CC} = 1.2 \text{ V}, 1.8 \text{ V}, 2.5 \text{ V}, 2.7 \text{ V}$  and  $3.3 \text{ V}$  respectively.

[3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:

$f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

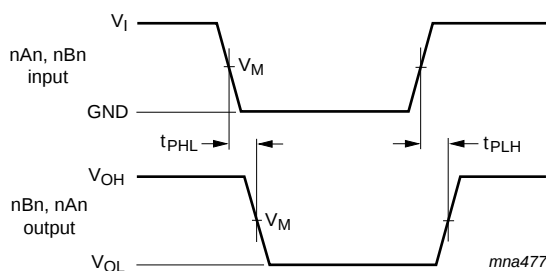
$C_L$  = output load capacitance in pF

$V_{CC}$  = supply voltage in Volts

$N$  = number of inputs switching

$\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

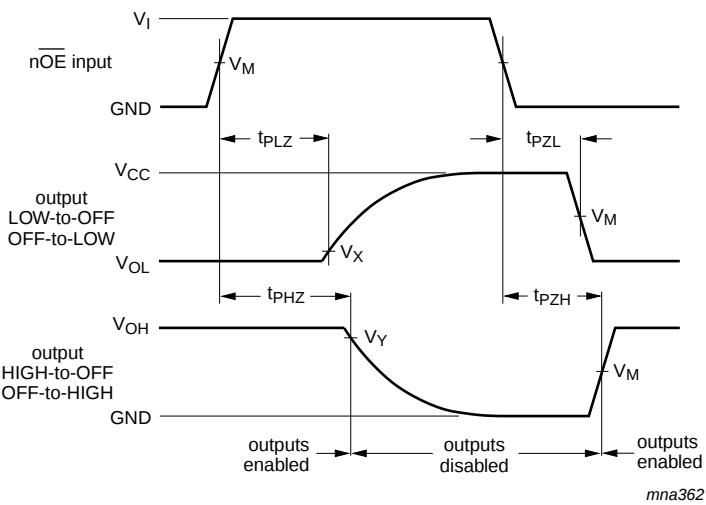
## 11. Waveforms



Measurement points are given in [Table 8](#).

Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 7. The input (nAn, nBn) to output (nBn, nAn) propagation delays**

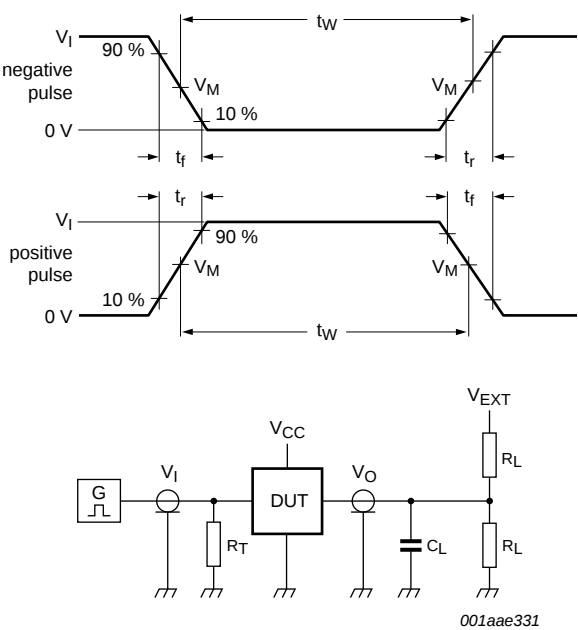


Measurement points are given in [Table 8](#).  
Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 8. 3-state enable and disable times**

**Table 8. Measurement points**

| Supply voltage   | $V_M$               | Input    |                       |                           |                           |
|------------------|---------------------|----------|-----------------------|---------------------------|---------------------------|
| $V_{CC}$         |                     | $V_I$    | $t_r = t_f$           | $V_X$                     | $V_Y$                     |
| 1.2 V            | $0.5 \times V_{CC}$ | $V_{CC}$ | $\leq 2.5 \text{ ns}$ | $V_{OL} + 0.15 \text{ V}$ | $V_{OH} - 0.15 \text{ V}$ |
| 1.65 V to 1.95 V | $0.5 \times V_{CC}$ | $V_{CC}$ | $\leq 2.5 \text{ ns}$ | $V_{OL} + 0.15 \text{ V}$ | $V_{OH} - 0.15 \text{ V}$ |
| 2.3 V to 2.7 V   | $0.5 \times V_{CC}$ | $V_{CC}$ | $\leq 2.5 \text{ ns}$ | $V_{OL} + 0.15 \text{ V}$ | $V_{OH} - 0.15 \text{ V}$ |
| 2.7 V            | 1.5 V               | 2.7 V    | $\leq 2.5 \text{ ns}$ | $V_{OL} + 0.3 \text{ V}$  | $V_{OH} - 0.3 \text{ V}$  |
| 3.0 V to 3.6 V   | 1.5 V               | 2.7 V    | $\leq 2.5 \text{ ns}$ | $V_{OL} + 0.3 \text{ V}$  | $V_{OH} - 0.3 \text{ V}$  |



Test data is given in [Table 9](#).

Definitions for test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$V_{EXT}$  = External voltage for measuring switching times.

**Fig 9. Test circuit for measuring switching times**

**Table 9. Test data**

| Supply voltage   | Input    |               | Load  |              | $V_{EXT}$          |                    |                    |
|------------------|----------|---------------|-------|--------------|--------------------|--------------------|--------------------|
|                  | $V_I$    | $t_r, t_f$    | $C_L$ | $R_L$        | $t_{PLH}, t_{PHL}$ | $t_{PLZ}, t_{PZL}$ | $t_{PHZ}, t_{PZH}$ |
| 1.2 V            | $V_{CC}$ | $\leq 2$ ns   | 30 pF | 1 k $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 1.65 V to 1.95 V | $V_{CC}$ | $\leq 2$ ns   | 30 pF | 1 k $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 2.3 V to 2.7 V   | $V_{CC}$ | $\leq 2$ ns   | 30 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 2.7 V            | 2.7 V    | $\leq 2.5$ ns | 50 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 3.0 V to 3.6 V   | 2.7 V    | $\leq 2.5$ ns | 50 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |

12. Package outline

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1

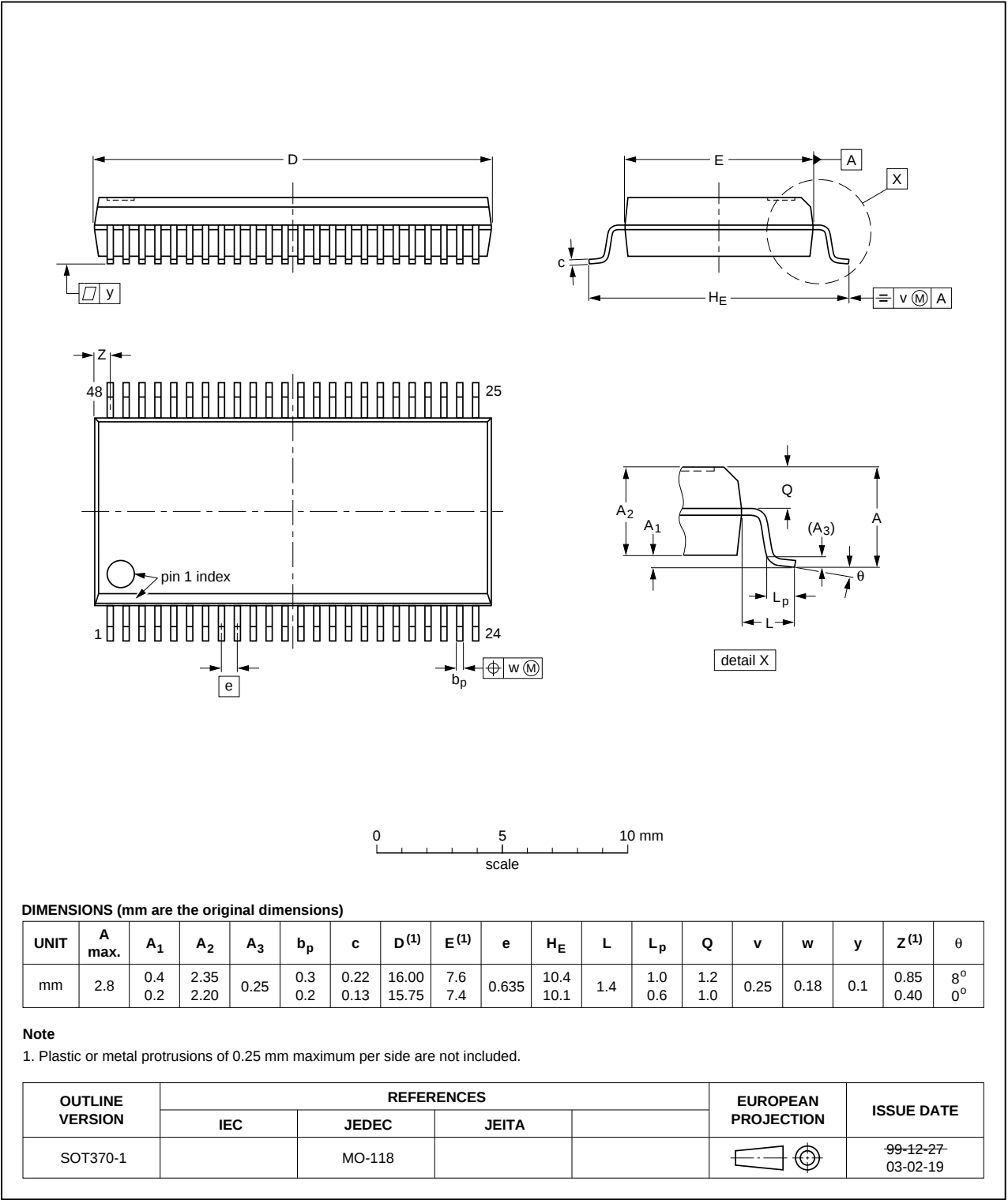


Fig 10. Package outline SOT370-1 (SSOP48)

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1

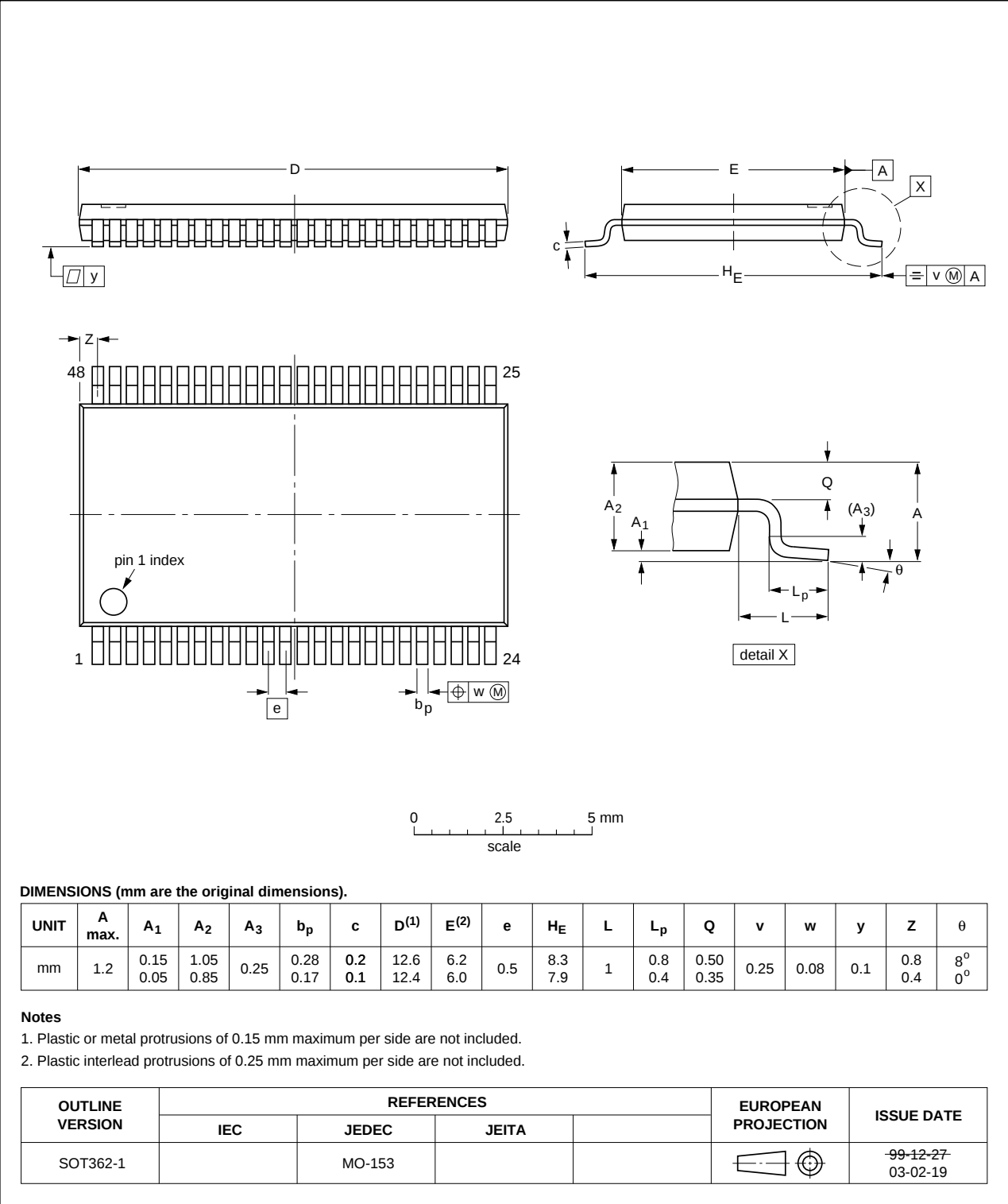


Fig 11. Package outline SOT362-1 (TSSOP48)

VFBGA56: plastic very thin fine-pitch ball grid array package; 56 balls; body 4.5 x 7 x 0.65 mm

SOT702-1

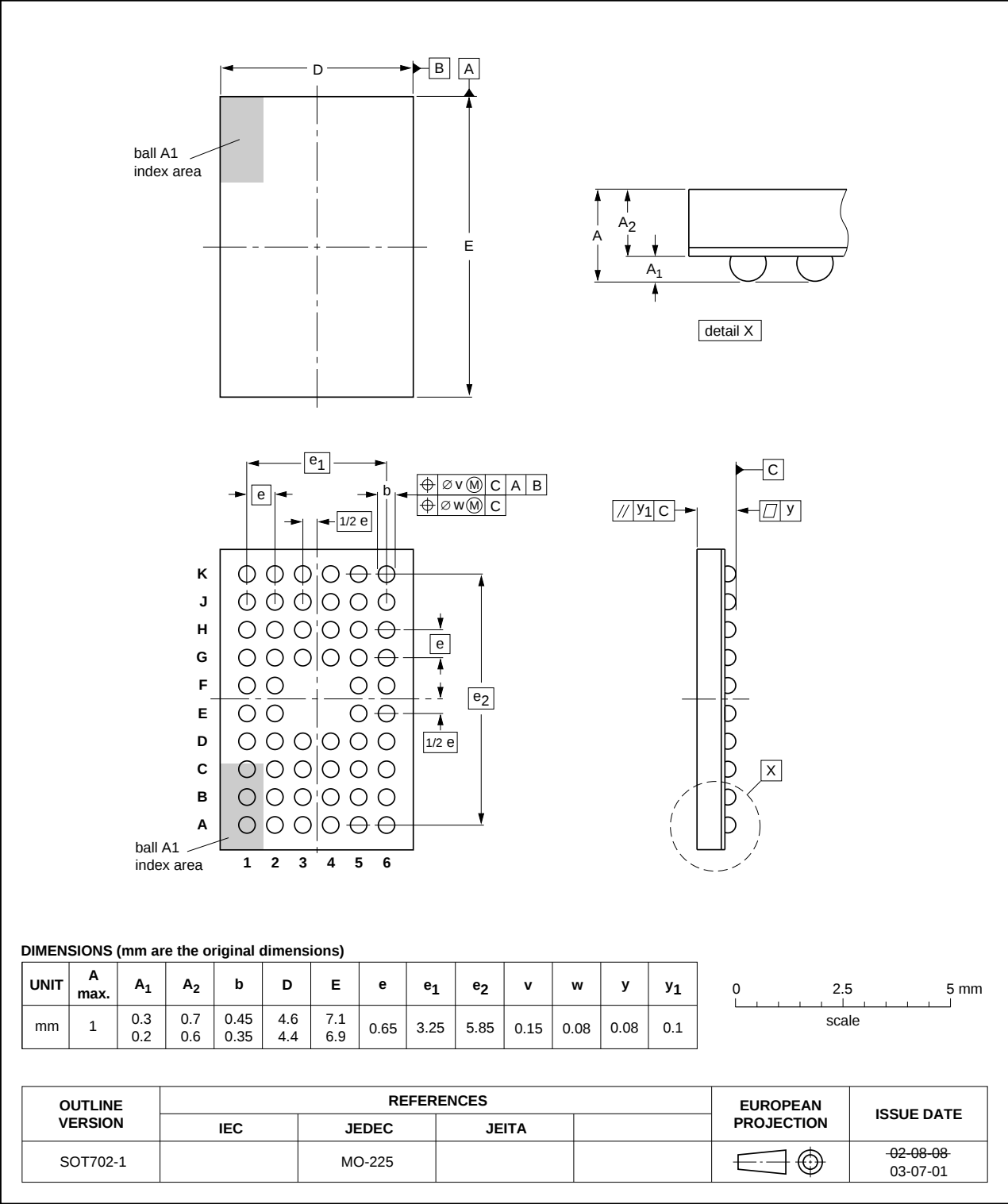


Fig 12. Package outline SOT702-1 (VFBGA56)

HXQFN60: plastic compatible thermal enhanced extremely thin quad flat package; no leads;  
60 terminals; body 4 x 6 x 0.5 mm

SOT1134-2

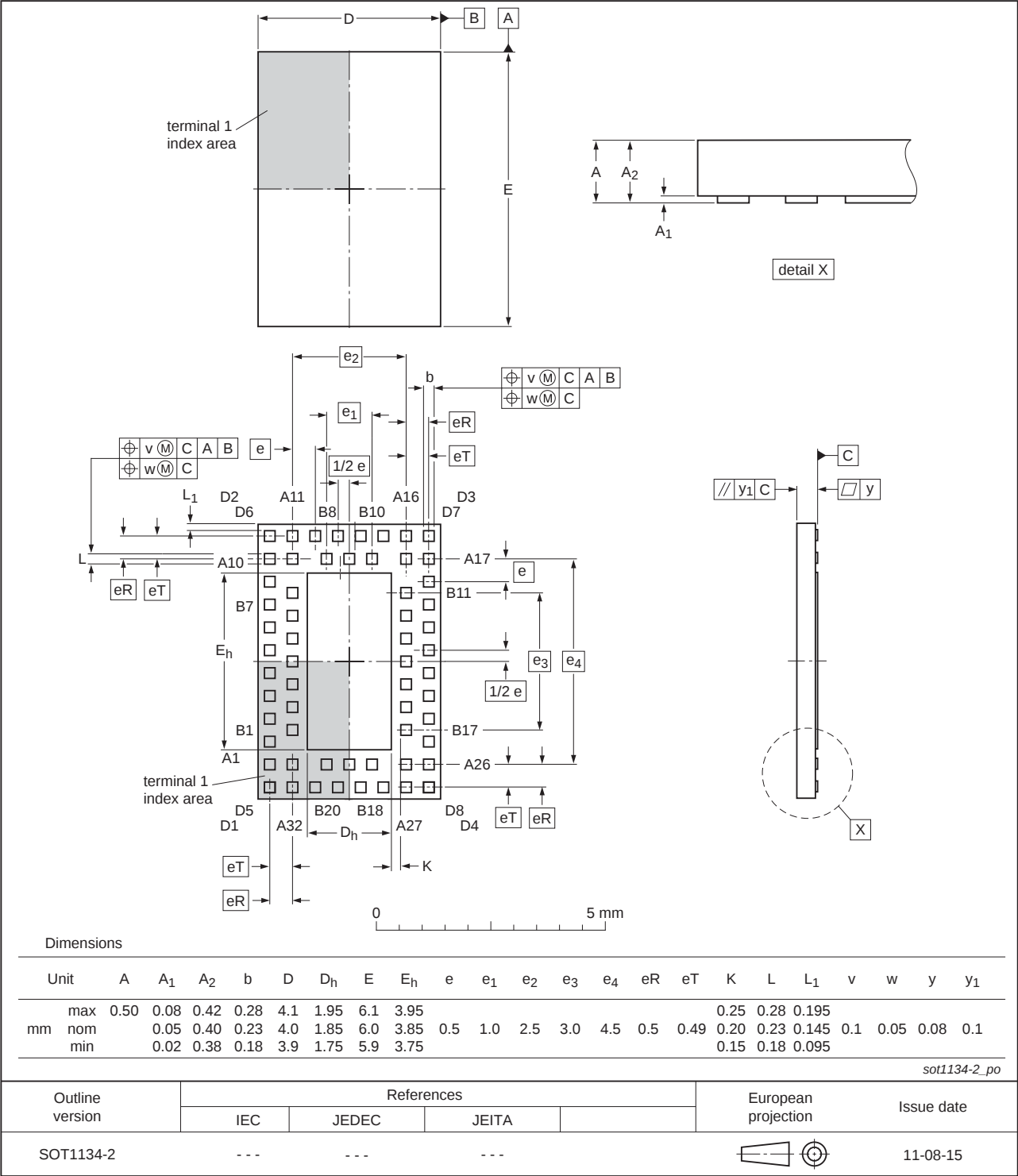


Fig 13. Package outline SOT1134-2 (HXQFN60)

## 13. Abbreviations

Table 10. Abbreviations

| Acronym | Description                 |
|---------|-----------------------------|
| CDM     | Charged Device Model        |
| DUT     | Device Under Test           |
| ESD     | ElectroStatic Discharge     |
| HBM     | Human Body Model            |
| MM      | Machine Model               |
| TTL     | Transistor-Transistor Logic |

## 14. Revision history

Table 11. Revision history

| Document ID                  | Release date                                                                                                                                                                                                              | Data sheet status     | Change notice | Supersedes                   |
|------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|---------------|------------------------------|
| 74LVC_LVCH16245A v.12        | 20120213                                                                                                                                                                                                                  | Product data sheet    | -             | 74LVC_LVCH16245A v.11        |
| Modifications:               | <ul style="list-style-type: none"> <li>For type number 74LVC16245ABX and 74LVCH16245ABX the sot code has changed to SOT1134-2.</li> </ul>                                                                                 |                       |               |                              |
| 74LVC_LVCH16245A v.11        | 20111208                                                                                                                                                                                                                  | Product data sheet    | -             | 74LVC_LVCH16245A v.10        |
| Modifications:               | <ul style="list-style-type: none"> <li><a href="#">Table 4</a>, <a href="#">Table 5</a>, <a href="#">Table 6</a>, <a href="#">Table 7</a>, and <a href="#">Table 9</a>: values added for lower voltage ranges.</li> </ul> |                       |               |                              |
| 74LVC_LVCH16245A v.10        | 20110623                                                                                                                                                                                                                  | Product data sheet    | -             | 74LVC_LVCH16245A v.9         |
| Modifications:               | <ul style="list-style-type: none"> <li>type numbers 74LVC16245ABQ and 74LVCH16245ABQ changed to 74LVC16245ABX and 74LVCH16245ABX.</li> <li><a href="#">Figure 6</a>: figure note 1 changed.</li> </ul>                    |                       |               |                              |
| 74LVC_LVCH16245A v.9         | 20100329                                                                                                                                                                                                                  | Product data sheet    | -             | 74LVC_LVCH16245A v.8         |
| 74LVC_LVCH16245A v.8         | 20081106                                                                                                                                                                                                                  | Product data sheet    | -             | 74LVC_LVCH16245A v.7         |
| 74LVC_LVCH16245A v.7         | 20031125                                                                                                                                                                                                                  | Product specification | -             | 74LVC_LVCH16245A v.6         |
| 74LVC_LVCH16245A v.6         | 20030130                                                                                                                                                                                                                  | Product specification | -             | 74LVC_LVCH16245A v.5         |
| 74LVC_LVCH16245A v.5         | 20021030                                                                                                                                                                                                                  | Product specification | -             | 74LVC_H16245A v.4            |
| 74LVC_H16245A v.4            | 19970925                                                                                                                                                                                                                  | Product specification | -             | 74LVC16245A_74LVCH16245A v.3 |
| 74LVC16245A_74LVCH16245A v.3 | 19970925                                                                                                                                                                                                                  | Product specification | -             | 74LVC16245A v.2              |
| 74LVC16245A v.2              | 19970801                                                                                                                                                                                                                  | Product specification | -             | 74LVC16245A v.1              |
| 74LVC16245A v.1              | -                                                                                                                                                                                                                         | -                     | -             | -                            |

## 15. Legal information

### 15.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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## 17. Contents

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|           |                                               |           |
|-----------|-----------------------------------------------|-----------|
| <b>1</b>  | <b>General description</b> .....              | <b>1</b>  |
| <b>2</b>  | <b>Features and benefits</b> .....            | <b>1</b>  |
| <b>3</b>  | <b>Ordering information</b> .....             | <b>2</b>  |
| <b>4</b>  | <b>Functional diagram</b> .....               | <b>2</b>  |
| <b>5</b>  | <b>Pinning information</b> .....              | <b>4</b>  |
| 5.1       | Pinning .....                                 | 4         |
| 5.2       | Pin description .....                         | 6         |
| <b>6</b>  | <b>Functional description</b> .....           | <b>6</b>  |
| <b>7</b>  | <b>Limiting values</b> .....                  | <b>7</b>  |
| <b>8</b>  | <b>Recommended operating conditions</b> ..... | <b>7</b>  |
| <b>9</b>  | <b>Static characteristics</b> .....           | <b>8</b>  |
| <b>10</b> | <b>Dynamic characteristics</b> .....          | <b>9</b>  |
| <b>11</b> | <b>Waveforms</b> .....                        | <b>10</b> |
| <b>12</b> | <b>Package outline</b> .....                  | <b>13</b> |
| <b>13</b> | <b>Abbreviations</b> .....                    | <b>17</b> |
| <b>14</b> | <b>Revision history</b> .....                 | <b>17</b> |
| <b>15</b> | <b>Legal information</b> .....                | <b>18</b> |
| 15.1      | Data sheet status .....                       | 18        |
| 15.2      | Definitions .....                             | 18        |
| 15.3      | Disclaimers .....                             | 18        |
| 15.4      | Trademarks .....                              | 19        |
| <b>16</b> | <b>Contact information</b> .....              | <b>19</b> |
| <b>17</b> | <b>Contents</b> .....                         | <b>20</b> |

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